

Product Change Notification - JAON-24EPKL576

Date:

08 Nov 2019

Product Category:

Access Networks; Line Drivers; Broadband Gateway; Network Synchronization; Clock Synthesis; Voice Audio; Jitter Attenuators; Clock and Timing - Clock Generation; Clock and Timing - Clock and Data Distribution; Others

Affected CPNs:



Notification subject:

CCB 3970 Final Notice: Qualification of palladium coated copper with gold flash (CuPdAu) bond wire for selected MSCC products available in various packages at ASEM assembly site.

Notification text:

PCN Status:

Final notification

PCN Type:

Manufacturing Change

Microchip Parts Affected:

Please open one of the icons found in the Affected CPNs section above.

NOTE: For your convenience Microchip includes identical files in two formats (.pdf and .xls)

Description of Change:

Qualification of palladium coated copper with gold flash (CuPdAu) bond wire for selected MSCC products available in various packages at ASEM assembly site.

Pre Change:

Assembled at ASEM assembly site using palladium coated copper (PdCu) or Copper (Cu) bond wire.

Post Change:

Assembled at ASEM assembly site using palladium coated copper with gold flash (CuPdAu) bond wire

Pre and Post Change Summary:

	Pre Change	Post Change		
Assembly Site	ASE Group -Malaysia (ASEM)	ASE Group -Malaysia (ASEM)		
Wire material				
Die attach material	See attached pre and post change per affected package type			
Molding compound material				
Lead frame material				

Impacts to Data Sheet:

None

Change Impact:

None

Reason for Change:

To improve manufacturability by qualifying palladium coated copper with gold flash (CuPdAu) bond



wire material.

Change Implementation Status:

In Progress

Estimated First Ship Date:

March 1, 2020 (date code: 2010)

NOTE: Please be advised that after the estimated first ship date customers may receive pre and

post change parts

Time Table Summary:

	November 2019				->	March 2020					
Workweek	44	45	46	47	48	,	10	11	12	13	14
Qual Report Availability		X									
Final PCN Issue Date		X									
Estimated Implementation											
Date							^				

Method to Identify Change:

Traceability code

Qualification Report:

Please open the attachments included with this PCN labeled as PCN # Qual Report.

Revision History:

November 8, 2019: Issued final notification. Attached the qualification report. Provided estimated first ship date to be on March 1, 2020.

The change described in this PCN does not alter Microchip's current regulatory compliance regarding the material content of the applicable products.

Attachment(s):

PCN_JAON-24EPKL576_Qual_Report.pdf PCN_JAON-24EPKL576_Pre and Post Change Summary.pdf

Please contact your local <u>Microchip sales office</u> with questions or concerns regarding this notification.

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If you wish to change your PCN profile, including opt out, please go to the PCN home page select login and sign into your myMicrochip account. Select a profile option from the left navigation bar and make the applicable selections.

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Affected Catalog Part Numbers (CPN)

LE79112AKVCT

LE79114KVC

LE79124KVC

LE79124KVCT

LE79128KVC

LE79128KVCT

LE79234KVC

LE792388TVC

LE792388TVCT

LE792388VQC

LE792388VQCT

LE79252BTC

LE79252BTCT

LE79271AMQC

LE79271AMQCT

LE79271MQC

LE79271MQCT

LE79272PQC

LE79272PQCT

LE79Q2281DVC

LE79Q2281DVCT

LE79Q2284MVC

LE79Q2284MVCT

LE79R70-1FQC

LE87100NQC

LE87100NQCT

LE87251NQC

LE87251NQCT

LE87270NQC

LE87270NQCT

LE87281NQC

LE87281NQCT

LE87285NQC

LE87285NQCT

LE87286NQC

LE87290YQC

LE87290YQCT

LE87401NQC

LE87401NQCT

LE87411NQC

LE87411NQCT

LE87501NQC

LE87501NQCT

LE87502MQC

LE87502MQCT

LE87511NQC

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JAON-24EPKL576 - CCB 3970 Final Notice: Qualification of palladium coated copper with gold flash (CuPdAu) bond wire for selected MSCC products available in various packages at ASEM assembly site. LE9530DPQC LE9530DPQCT LE9540CUQC LE9540CUQCT LE9540DUQC LE9540DUQCT LE9541CUQC DS3105LN2 DS3106LN2 LE57D111BTC LE57D111BTCT LE57D121BTC LE57D121BTCT LE57D122BTC LE57D122BTCT LE58QL021BVC LE58QL021BVCT LE58QL022BVC LE58QL022BVCT LE58QL061BVC LE58QL061BVCT LE58QL063HVC LE58QL063HVCT LE79112AKVC LE9541CUQCT LE9541DUQC LE9541DUQCT LE9551CMQC LE9551CMQCT LE9551DMQC LE9551DMQCT LE9622RQC LE9622RQCT LE9632RQC LE9632RQCT LE9641PQC LE9641PQCT LE9642PQC LE9642PQCT LE9651PQC LE9651PQCT LE9652PQC LE9652PQCT LE9661WQC LE9661WQCT LE9662WQC LE9662WQCT LE9672WQC LE9672WQCT

JAON-24EPKL576 - CCB 3970 Final Notice: Qualification of palladium coated copper with gold flash (CuPdAu) bond wire for selected MSCC products available in various packages at ASEM assembly site. MAX3674ECM2 MAX3674ECM2T MT8816AF1 MT9074AL1 ZL30100QDG1 ZL30101QDG1 ZL30102QDG1 ZL30105QDG1 ZL30106QDG1 ZL30107GGG2 ZL30109QDG1 ZL30111QDG1 ZL30116GGG2V2 ZL30117GGG2 ZL30119GGG2 ZL30120GGG2 ZL30121GGG2V2 ZL30122GGG2 ZL30123GGG2 ZL30130GGG2 ZL30131GGG2 ZL30132GGG2 ZL30136GGG2 ZL30138GGG2 ZL30142GGG2 ZL30143GGG2 ZL30145GGG2 ZL30146GGG2 ZL30150GGG2 ZL30152GGG2 ZL30153GGG2 ZL30154GGG2 ZL30155GGG2 ZL30156GGG2 ZL30157GGG2 ZL30158GGG2 ZL30159GGG2 ZL30160GGG2 ZL30160-GGG2-WH ZL30161GD ZL30161GDG2 ZL30162 ZL30162GDG2 ZL30163GDG2 ZL30163-GDG2-WE ZL30164GDG2 ZL30164GDG2Q036 ZL30164GDG2Q03M ZL30164-GDG2-WE

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ZL38005QCG1	
ZL38012LDF1	
ZL38012LDG1	
ZL38015QCG1	
ZL38040LDF1	
ZL38040LDG1	
ZL38042LDF1	
ZL38042LDG1	
ZL38050LDF1	
ZL38050LDG1	
ZL38051LDF1	
ZL38051LDG1	
ZL38052LDF1	
ZL38052LDG1	
ZL38060LDF1	
ZL38060LDG1	
ZL38062LDF1	
ZL38062LDG1	
ZL38063LDF1	
ZL38063LDG1	
ZL38065QCG1	
ZL38067LDF1	
ZL38067LDG1	
ZL38080LDF1	
ZL38080LDG1	
ZL38090LDF1	
ZL38090LDG1	
ZL38AMBLDF1	
ZL38AMBLDG1	
ZL40200LDF1	
ZL40200LDG1	
ZL40201LDF1	
ZL40201LDG1	
ZL40202LDF1	
ZL40202LDG1	
ZL40203LDF1	
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ZL40207LDG1	
ZL40208LDF1	
ZL40208LDG1	
ZL40209LDF1	
ZL40209LDG1	

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ZL40250LDG1
ZL40252LDF1
ZL40252LDG1
ZL40260LDF1
ZL40260LDG1
ZL40260QGF1
ZL40260QGG1
ZL50232QCG1
ZL50233QCG1
ZL50234QCG1
ZL50235QCG1
ZL79124GDG2
ZL792388GDG2
ZL792588GDG2
ZL80018GGG2
ZL80020GDG2
ZL80025GGG2
ZL80026LDF1
ZL80026LDG1
ZL80027LDF1
ZL80027LDG1
ZL80143GGG2
ZL88103LDF1
ZL88103LDG1
ZL88105LDF1
ZL88105LDG1
ZL88107LDF1
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